

APPROVAL SHEET

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CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

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Submitted by: Approved by: DATE: Chung Cheng YC Lin 9-Aug-12

SEA & LAND ELECTRONIC CORP.



mSMD150-24V

Features

Surface Mount Devices

 Surface Mount packaging for automated assembly

Lead free device Size 4.5*3.2 mm/0.18*0.12 inch

power supply, up to 60V and a load to be

Applications

- protected, including:
- Computer mother board, Modem. USB hub

Almost anywhere there is a low voltage

PDAs & Charger, Analog & digital line card

Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

Performance Specification

						Maxii	mum	Resis	stance		
Model	V _{max}	Imax	hold	I _{trip}	P_d	Time T	o Trip			Agency A	Approval
Woder			@25°C	@25°C	Тур.	Current	Time	Ri min	R1 _{max}	UL	τυν
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	UL	100
mSMD150-24V	24.0	100	1.50	3.00	0.8	8.0	0.50	0.040	0.160		
Ihold = Hold Current.	Ihold = Hold Current. Maximum current device will not trip in 25°C still air.										
Itrip = Trip Current. N	1inimum curre	ent at which th	e device will a	always trip in 2	25°C still air.						
Vmax = Maximum ope	rating voltage	device can w	ithstand witho	out damage a	t rated curren	t (Imax).					
Imax = Maximum fau	It current devi	ce can withsta	and without da	amage at rate	d voltage (Vn	nax).					
Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.											
Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.											
R1 _{max} = Maximum device resistance is measured one hour post reflow.											
CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.											

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the trippe	ed state is 125 °C	

Agency Approvals :

UL pending

Regulation/Standard:



Ihold Versus Temperature

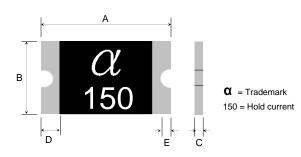
Model	Maximum ambient operating temperature (T_{mao}) vs. hold current (I_{hold})								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
mSMD150-24V	2.28	2.03	1.75	1.50	1.21	1.07	0.93	0.79	0.58

mSMD150-24V

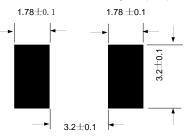
Alpha-Top (Sea & Land Alliance)

Construction And Dimension (Unit:mm)								
Madel A B C D								
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
mSMD150-24V	4.37	4.73	3.07	3.41	0.60	1.30	0.30	0.25

Dimensions & Marking



Recommended Pad Layout (mm)



Termination Pad Characteristics

Terminal pad materials :

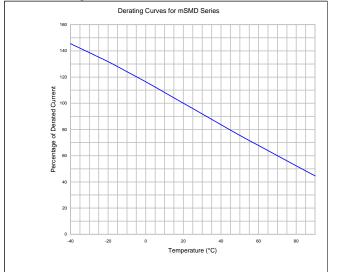
Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Terminal pad solderability :

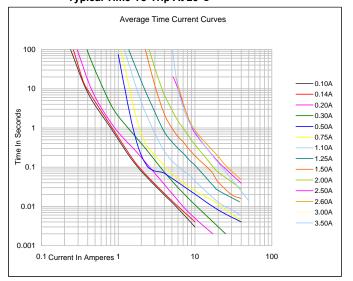
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



WARNING:

 Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

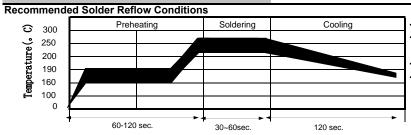
· Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.

Requests that customers comply with our recommended solder and lavouts and recommended reflow profile. Improver hoard lavouts or reflow profile could negatively impact solderabilit

mSMD150-24V

Alpha-Top (Sea & Land Alliance)

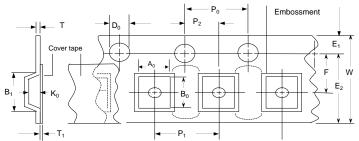


- Recommended reflow methods : IR, vapor phase oven, hot air oven. Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch). Devices can be cleaned using standard method and solvents.
- Note : If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

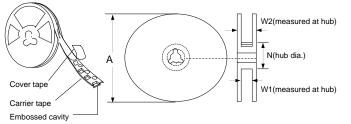
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	12 ± 0.3
P0	4.0 ± 0.10
P1	8.0 ± 0.10
P2	2.0 ± 0.05
A0	3.5 ± 0.23
B0	5.1 ± 0.15
B1max.	5.9
D0	1.5 + 0.1, -0
F	5.5 ± 0.05
E1	1.75 ± 0.10
E2min.	10.25
Tmax.	0.6
T1max.	0.1
КО	0.9 ± 0.15
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	12.4 + 2.0, -0.0
W2max.	18.4

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance
- if storage conditions are exceeded.

Order Information

Order Information			Packaging
mSMD	150	-24V	Tape & Reel Quantity
Product name	Hold	Max	
Size 4532mm/1812 inch	Current	Voltage	1,500 pcs/reel
SMD : surface mount device	1.50A		
	1.50A		

Tape & reel packaging per EIA481-1

Labeling Information

Sea & Land Electronic Corp.	
HF Pb RoHS	
Model:	
Part no.:	
Spec.:	
Lot no.:	
Q'ty:	
]儲: 密封! 溫度: 18~33℃/濕度: 30~60% A	